

International **IR** Rectifier

PRELIMINARY

PD -91784

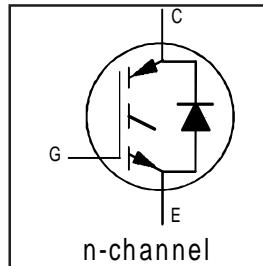
IRG4BC10SD

Standard Speed CoPack
IGBT

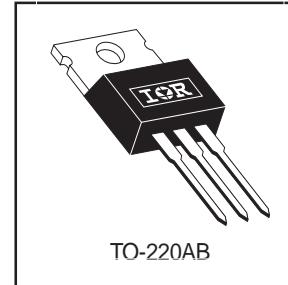
INSULATED GATE BIPOLAR TRANSISTOR WITH ULTRAFAST SOFT RECOVERY DIODE

Features

- Extremely low voltage drop 1.1Vtyp. @ 2A
- S-Series: Minimizes power dissipation at up to 3 KHz PWM frequency in inverter drives, up to 4 KHz in brushless DC drives.
- Very Tight Vce(on) distribution
- IGBT co-packaged with HEXFRED™ ultrafast, ultra-soft-recovery anti-parallel diodes for use in bridge configurations
- Industry standard TO-220AB package



$V_{CES} = 600V$
 $V_{CE(on)} \text{ typ.} = 1.10V$
 $@V_{GE} = 15V, I_C = 2.0A$



Benefits

- Generation 4 IGBT's offer highest efficiencies available
- IGBT's optimized for specific application conditions
- HEXFRED diodes optimized for performance with IGBT's. Minimized recovery characteristics require less/no snubbing
- Lower losses than MOSFET's conduction and Diode losses

Absolute Maximum Ratings

| | Parameter | Max. | Units |
|---------------------------|------------------------------------|-----------------------------------|-------|
| V_{CES} | Collector-to-Emitter Voltage | 600 | V |
| $I_C @ T_C = 25^\circ C$ | Continuous Collector Current | 14 | A |
| $I_C @ T_C = 100^\circ C$ | Continuous Collector Current | 8.0 | |
| I_{CM} | Pulsed Collector Current ① | 18 | |
| I_{LM} | Clamped Inductive Load Current ② | 18 | |
| $I_F @ T_C = 100^\circ C$ | Diode Continuous Forward Current | 4.0 | |
| I_{FM} | Diode Maximum Forward Current | 18 | W |
| V_{GE} | Gate-to-Emitter Voltage | ± 20 | |
| $P_D @ T_C = 25^\circ C$ | Maximum Power Dissipation | 38 | |
| $P_D @ T_C = 100^\circ C$ | Maximum Power Dissipation | 15 | |
| T_J | Operating Junction and | $-55 \text{ to } +150$ | |
| T_{STG} | Storage Temperature Range | $^\circ C$ | |
| | Soldering Temperature, for 10 sec. | 300 (0.063 in. (1.6mm) from case) | |
| | Mounting Torque, 6-32 or M3 Screw. | 10 lbf-in (1.1 N•m) | |

Thermal Resistance

| | Parameter | Min. | Typ. | Max. | Units |
|-----------------|---|------|-----------|------|--------------|
| $R_{\theta JC}$ | Junction-to-Case - IGBT | — | — | 3.3 | $^\circ C/W$ |
| $R_{\theta JC}$ | Junction-to-Case - Diode | — | — | 7.0 | |
| $R_{\theta CS}$ | Case-to-Sink, flat, greased surface | — | 0.50 | — | |
| $R_{\theta JA}$ | Junction-to-Ambient, typical socket mount | — | — | 80 | |
| Wt | Weight | — | 2.0(0.07) | — | g (oz) |

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Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

| | Parameter | Min. | Typ. | Max. | Units | Conditions |
|---|---|------|------|-----------|----------------------|---|
| $V_{(\text{BR})\text{CES}}$ | Collector-to-Emitter Breakdown Voltage ^③ | 600 | — | — | V | $V_{\text{GE}} = 0\text{V}$, $I_C = 250\mu\text{A}$ |
| $\Delta V_{(\text{BR})\text{CES}}/\Delta T_J$ | Temperature Coeff. of Breakdown Voltage | — | 0.64 | — | V/ $^\circ\text{C}$ | $V_{\text{GE}} = 0\text{V}$, $I_C = 1.0\text{mA}$ |
| $V_{\text{CE}(\text{on})}$ | Collector-to-Emitter Saturation Voltage | — | 1.58 | 1.7 | V | $I_C = 8.0\text{A}$ $V_{\text{GE}} = 15\text{V}$ |
| | | — | 2.05 | — | | $I_C = 14.0\text{A}$ See Fig. 2, 5 |
| | | — | 1.68 | — | | $I_C = 8.0\text{A}$, $T_J = 150^\circ\text{C}$ |
| $V_{\text{GE}(\text{th})}$ | Gate Threshold Voltage | 3.0 | — | 6.0 | | $V_{\text{CE}} = V_{\text{GE}}$, $I_C = 250\mu\text{A}$ |
| $\Delta V_{\text{GE}(\text{th})}/\Delta T_J$ | Temperature Coeff. of Threshold Voltage | — | -9.5 | — | mV/ $^\circ\text{C}$ | $V_{\text{CE}} = V_{\text{GE}}$, $I_C = 250\mu\text{A}$ |
| g_{fe} | Forward Transconductance ^④ | 3.65 | 5.48 | — | S | $V_{\text{CE}} = 100\text{V}$, $I_C = 8.0\text{A}$ |
| I_{CES} | Zero Gate Voltage Collector Current | — | — | 250 | μA | $V_{\text{GE}} = 0\text{V}$, $V_{\text{CE}} = 600\text{V}$ |
| | | — | — | 1000 | | $V_{\text{GE}} = 0\text{V}$, $V_{\text{CE}} = 600\text{V}$, $T_J = 150^\circ\text{C}$ |
| V_{FM} | Diode Forward Voltage Drop | — | 1.5 | 1.8 | V | $I_C = 4.0\text{A}$ See Fig. 13 |
| | | — | 1.4 | 1.7 | | $I_C = 4.0\text{A}$, $T_J = 150^\circ\text{C}$ |
| I_{GES} | Gate-to-Emitter Leakage Current | — | — | ± 100 | nA | $V_{\text{GE}} = \pm 20\text{V}$ |

Switching Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

| | Parameter | Min. | Typ. | Max. | Units | Conditions |
|----------------------------|--|------|------|------|------------------|--|
| Q_g | Total Gate Charge (turn-on) | — | 15 | 22 | nC | $I_C = 8.0\text{A}$ |
| Q_{ge} | Gate - Emitter Charge (turn-on) | — | 2.42 | 3.6 | | $V_{\text{CC}} = 400\text{V}$ See Fig. 8 |
| Q_{gc} | Gate - Collector Charge (turn-on) | — | 6.53 | 9.8 | | $V_{\text{GE}} = 15\text{V}$ |
| $t_{\text{d}(\text{on})}$ | Turn-On Delay Time | — | 76 | — | ns | $T_J = 25^\circ\text{C}$ |
| t_r | Rise Time | — | 32 | — | | $I_C = 8.0\text{A}$, $V_{\text{CC}} = 480\text{V}$ |
| $t_{\text{d}(\text{off})}$ | Turn-Off Delay Time | — | 815 | 1200 | | $V_{\text{GE}} = 15\text{V}$, $R_G = 100\Omega$ |
| t_f | Fall Time | — | 720 | 1080 | | Energy losses include "tail" and diode reverse recovery. |
| E_{on} | Turn-On Switching Loss | — | 0.31 | — | | See Fig. 9, 10, 18 |
| E_{off} | Turn-Off Switching Loss | — | 3.28 | — | | |
| E_{ts} | Total Switching Loss | — | 3.60 | 10.9 | mJ | |
| E_{ts} | Total Switching Loss | — | 1.46 | 2.6 | | $I_C = 5.0\text{A}$ |
| $t_{\text{d}(\text{on})}$ | Turn-On Delay Time | — | 70 | — | | $T_J = 150^\circ\text{C}$, See Fig. 10,11, 18 |
| t_r | Rise Time | — | 36 | — | ns | $I_C = 8.0\text{A}$, $V_{\text{CC}} = 480\text{V}$ |
| $t_{\text{d}(\text{off})}$ | Turn-Off Delay Time | — | 890 | — | | $V_{\text{GE}} = 15\text{V}$, $R_G = 100\Omega$ |
| t_f | Fall Time | — | 890 | — | | Energy losses include "tail" and diode reverse recovery. |
| E_{ts} | Total Switching Loss | — | 3.83 | — | | See Fig. 9, 10, 18 |
| L_E | Internal Emitter Inductance | — | 7.5 | — | | Measured 5mm from package |
| C_{ies} | Input Capacitance | — | 280 | — | | |
| C_{oes} | Output Capacitance | — | 30 | — | pF | $V_{\text{GE}} = 0\text{V}$ |
| C_{res} | Reverse Transfer Capacitance | — | 4.0 | — | | $V_{\text{CC}} = 30\text{V}$ See Fig. 7 |
| $f = 1.0\text{MHz}$ | | | | | | |
| t_{rr} | Diode Reverse Recovery Time | — | 28 | 42 | ns | $T_J = 25^\circ\text{C}$ See Fig. |
| | | — | 38 | 57 | | $T_J = 125^\circ\text{C}$ 14 |
| I_{rr} | Diode Peak Reverse Recovery Current | — | 2.9 | 5.2 | A | $T_J = 25^\circ\text{C}$ See Fig. |
| | | — | 3.7 | 6.7 | | $T_J = 125^\circ\text{C}$ 15 |
| Q_{rr} | Diode Reverse Recovery Charge | — | 40 | 60 | nC | $T_J = 25^\circ\text{C}$ See Fig. |
| | | — | 70 | 105 | | $T_J = 125^\circ\text{C}$ 16 |
| $dI_{(\text{rec})M}/dt$ | Diode Peak Rate of Fall of Recovery During t_b | — | 280 | — | A/ μs | $T_J = 25^\circ\text{C}$ See Fig. |
| | | — | 235 | — | | $T_J = 125^\circ\text{C}$ 17 |

Details of note ① through ④ are on the last page

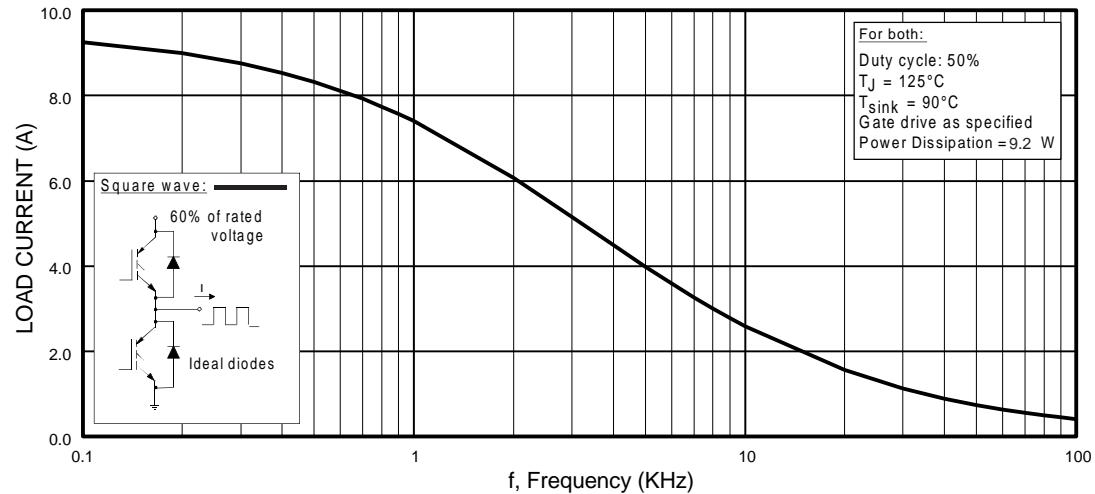


Fig. 1 - Typical Load Current vs. Frequency
 (Load Current = I_{RMS} of fundamental)

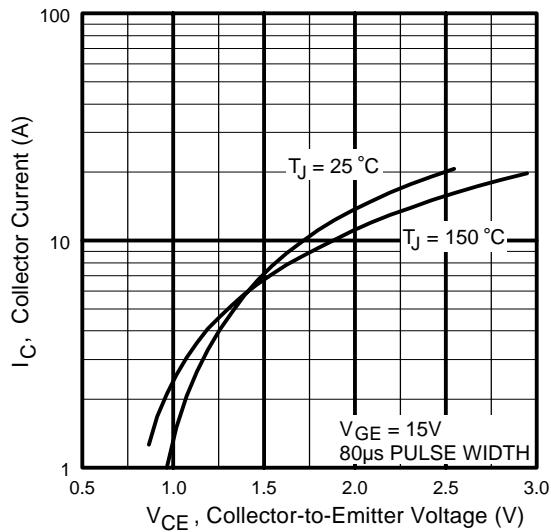


Fig. 2 - Typical Output Characteristics

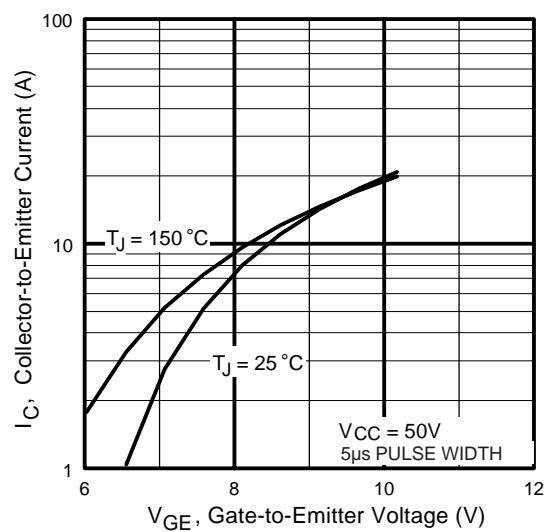


Fig. 3 - Typical Transfer Characteristics

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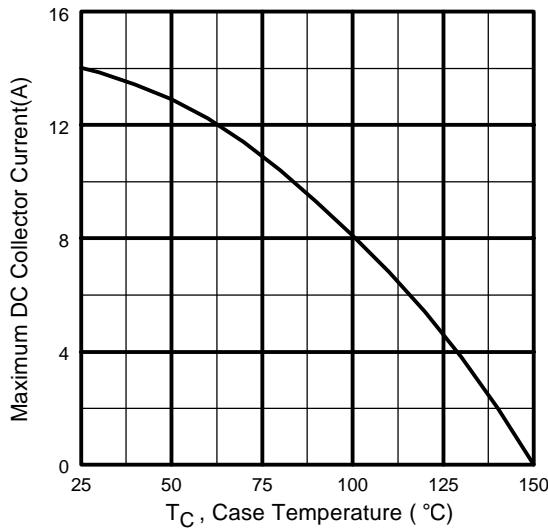


Fig. 4 - Maximum Collector Current vs. Case Temperature

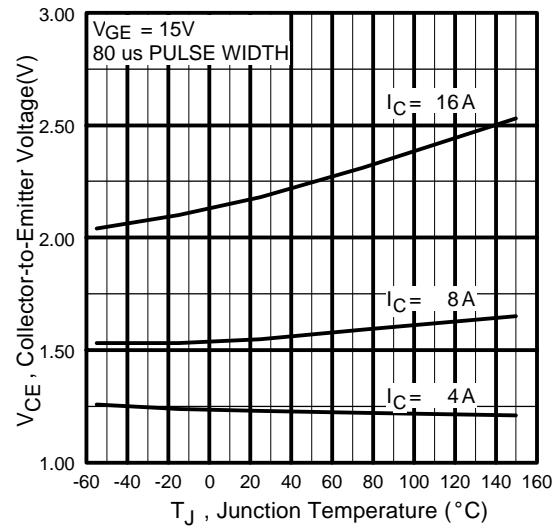


Fig. 5 - Typical Collector-to-Emitter Voltage vs. Junction Temperature

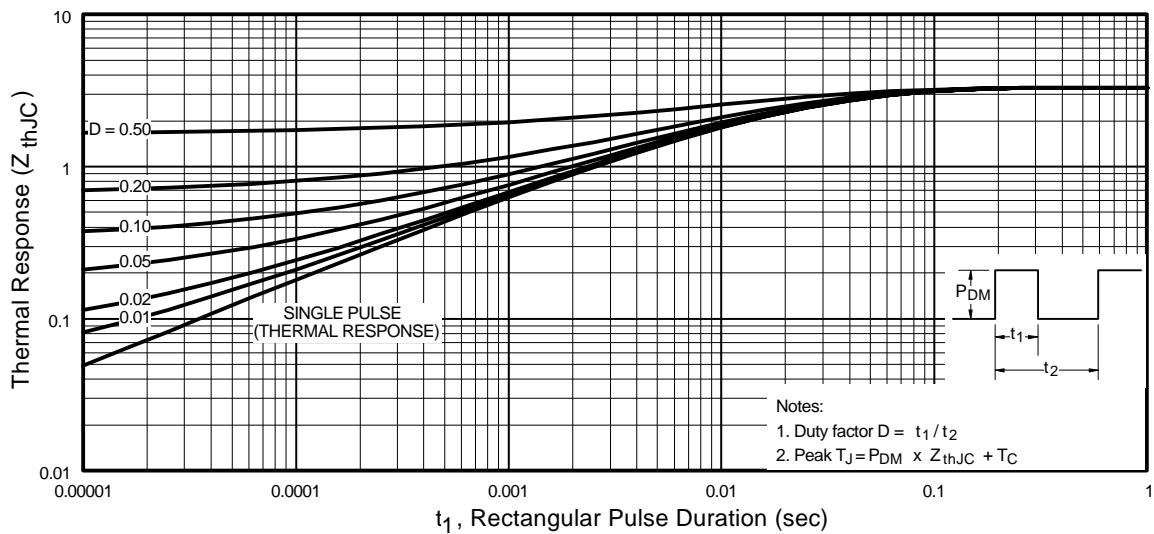


Fig. 6 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

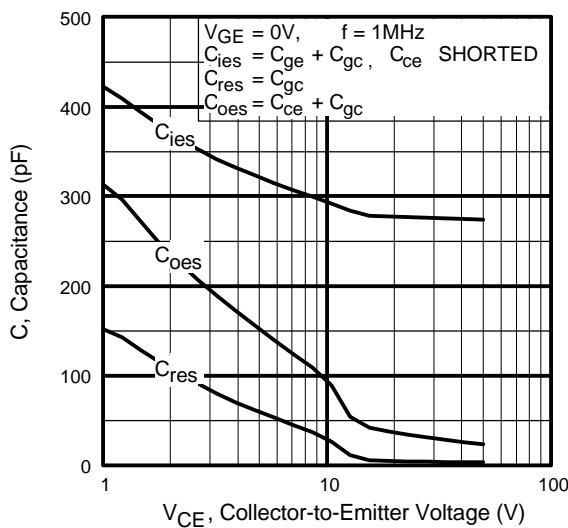


Fig. 7 - Typical Capacitance vs.
Collector-to-Emitter Voltage

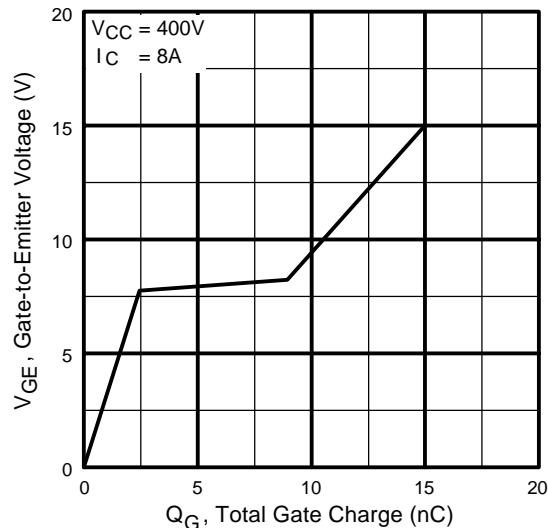


Fig. 8 - Typical Gate Charge vs.
Gate-to-Emitter Voltage

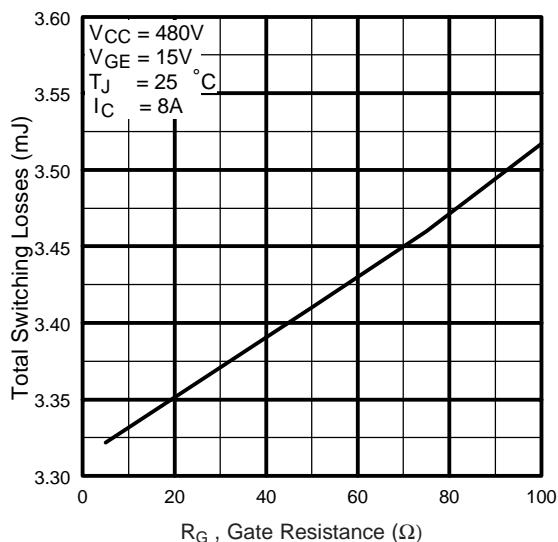


Fig. 9 - Typical Switching Losses vs. Gate
Resistance

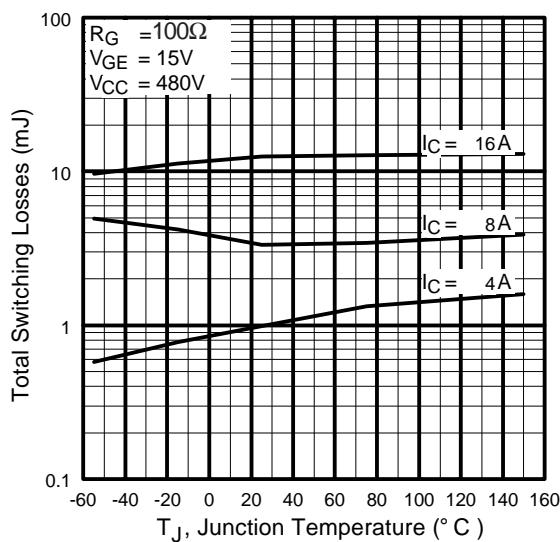


Fig. 10 - Typical Switching Losses vs.
Junction Temperature

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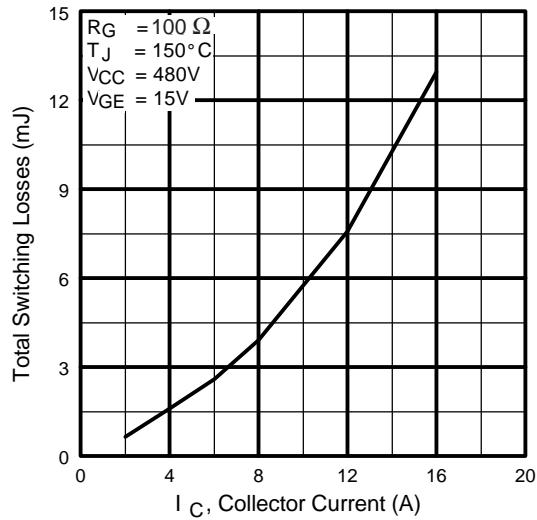


Fig. 11 - Typical Switching Losses vs.
Collector Current

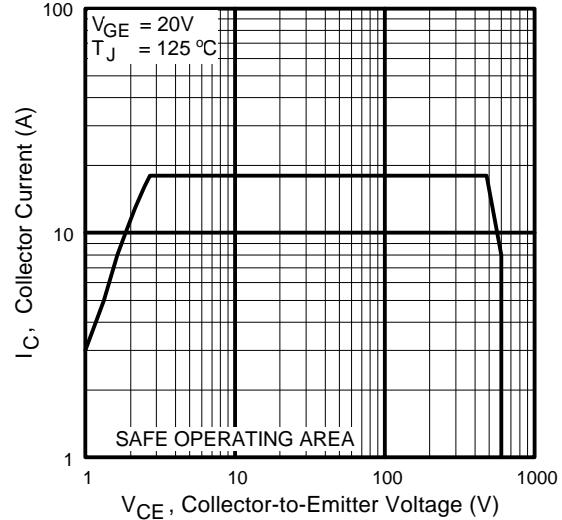


Fig. 12 - Turn-Off SOA

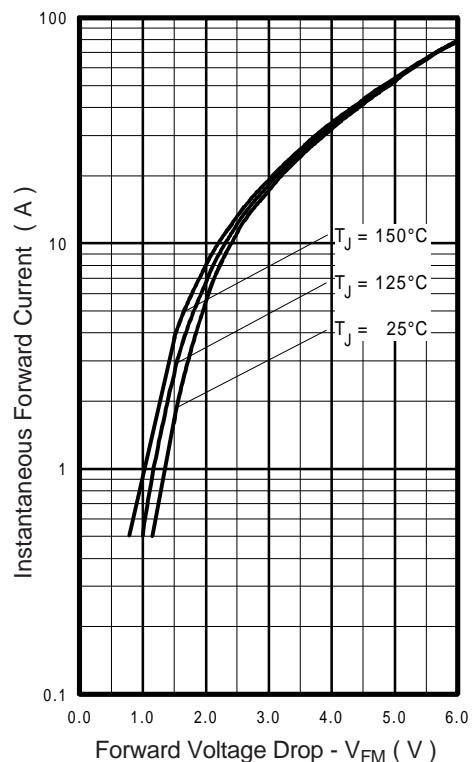


Fig. 13 - Maximum Forward Voltage Drop vs. Instantaneous Forward Current

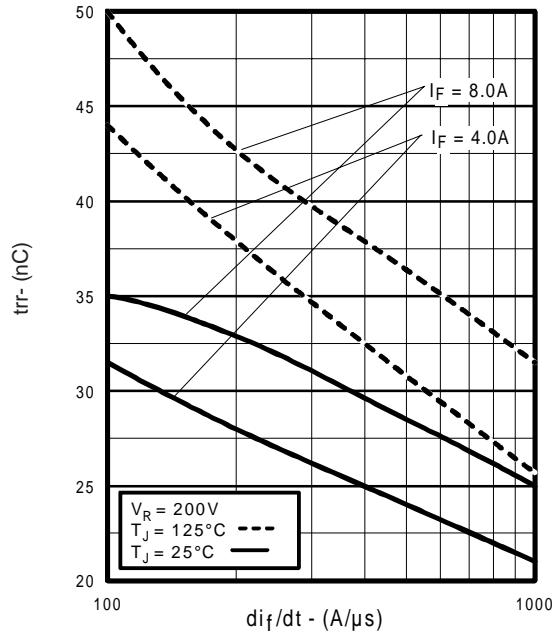


Fig. 14 - Typical Reverse Recovery vs. $\frac{di_f}{dt}$

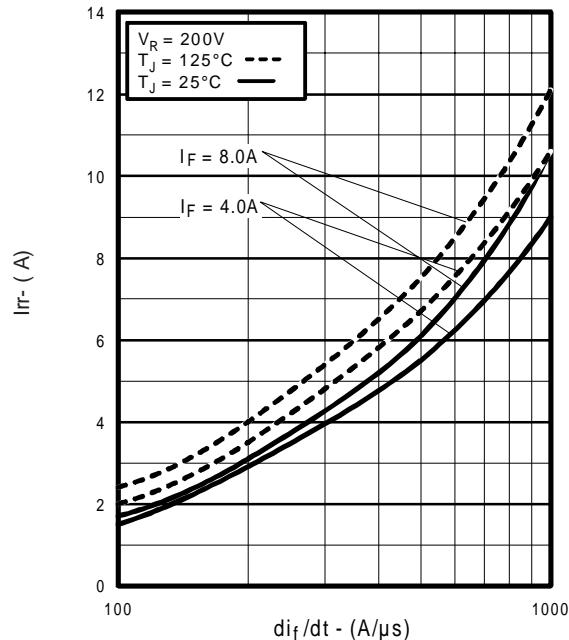


Fig. 15 - Typical Recovery Current vs. $\frac{di_f}{dt}$

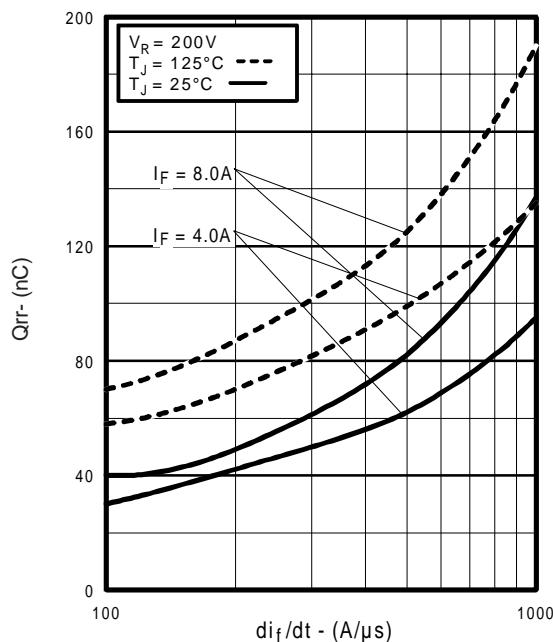


Fig. 16 - Typical Stored Charge vs. $\frac{di_f}{dt}$

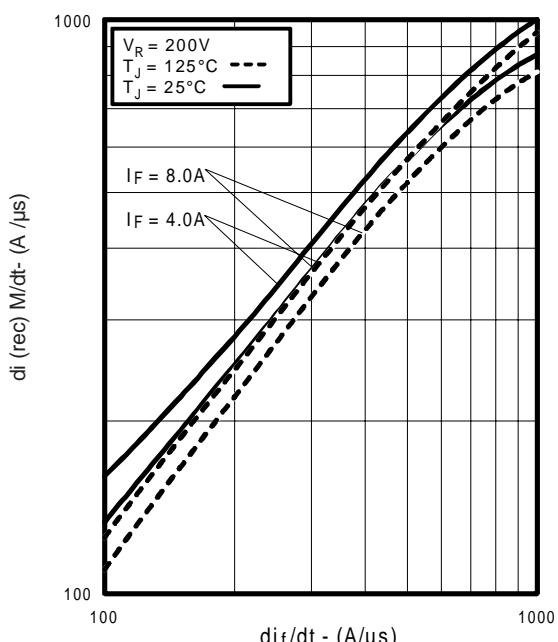


Fig. 17 - Typical $\frac{di_{(rec)M}}{dt}$ vs. $\frac{di_f}{dt}$,

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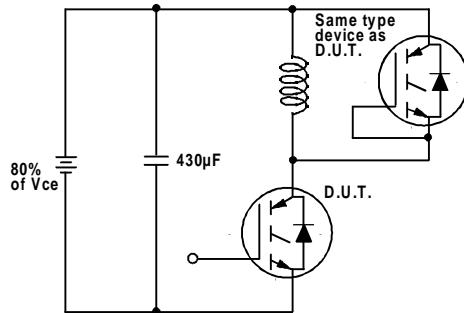


Fig. 18a - Test Circuit for Measurement of I_{LM}, E_{on}, E_{off(diode)}, t_{rr}, Q_{rr}, I_{rr}, t_{d(on)}, t_r, t_{d(off)}, t_f

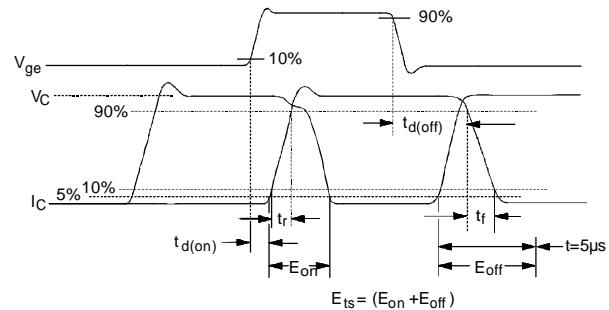


Fig. 18b - Test Waveforms for Circuit of Fig. 18a, Defining E_{off}, t_{d(off)}, t_f

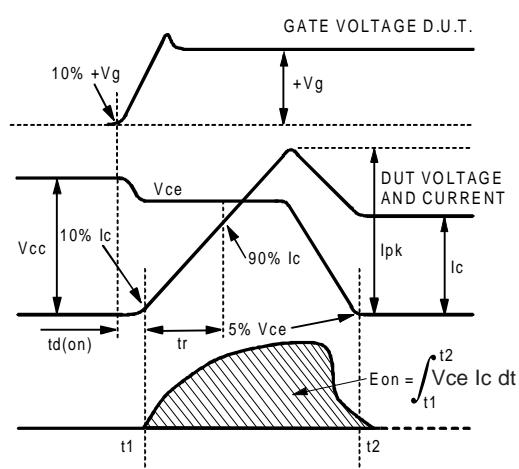


Fig. 18c - Test Waveforms for Circuit of Fig. 18a, Defining E_{on}, t_{d(on)}, t_r

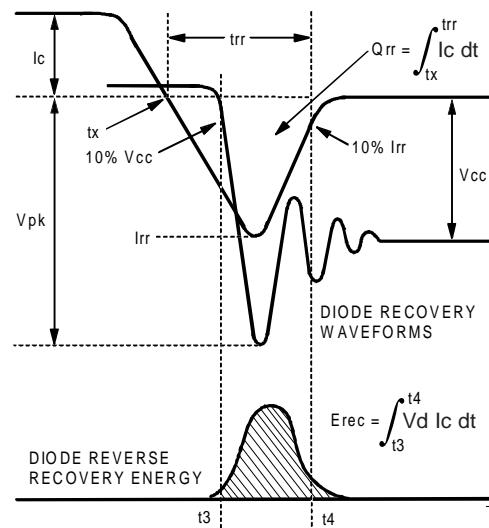


Fig. 18d - Test Waveforms for Circuit of Fig. 18a, Defining E_{rec}, t_{rr}, Q_{rr}, I_{rr}

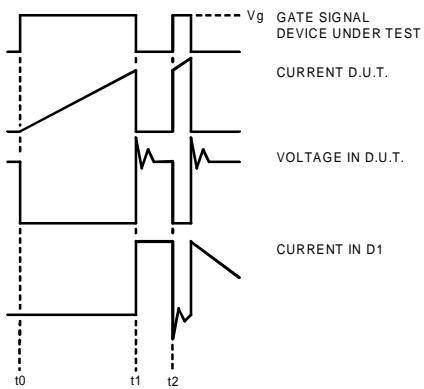


Figure 18e. Macro Waveforms for Figure 18a's Test Circuit

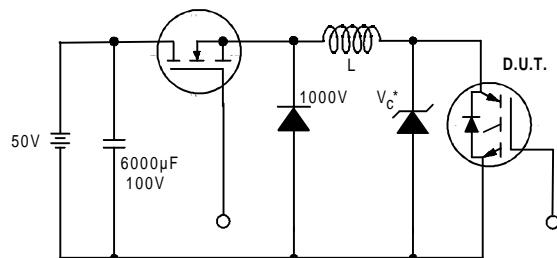


Figure 19. Clamped Inductive Load Test Circuit

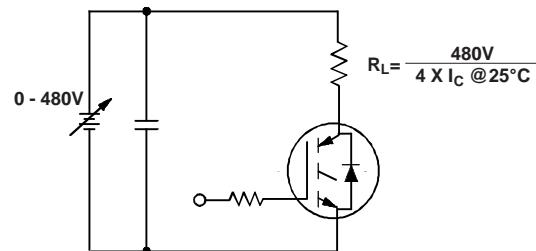


Figure 20. Pulsed Collector Current Test Circuit

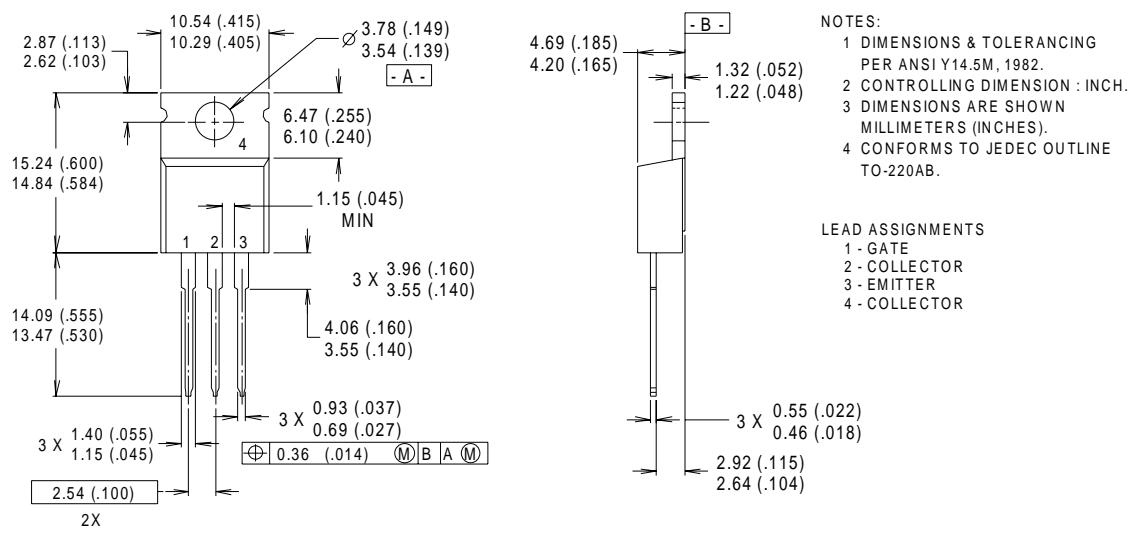
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Notes:

- ① Repetitive rating: $V_{GE}=20V$; pulse width limited by maximum junction temperature (figure 20)
- ② $V_{CC}=80\% (V_{CES})$, $V_{GE}=20V$, $L=10\mu H$, $R_G = 100W$ (figure 19)
- ③ Pulse width $\leq 80\mu s$; duty factor $\leq 0.1\%$.
- ④ Pulse width $5.0\mu s$, single shot.

Case Outline — TO-220AB



CONFORMS TO JEDEC OUTLINE TO-220AB
Dimensions in Millimeters and (Inches)

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